# FSV330AF

# **Schottky Barrier Rectifier**

#### Features

- Low Forward Voltage Drop: 0.5 V Maximum at 3 A, T<sub>A</sub> = 25°C
- Ultra Thin Profile Maximum Height of 1.0 mm
- High Surge Capacity
- UL Flammability 94V-0 Classification
- MSL 1
- Green Mold Compound
- These Devices are Pb-Free, Halogen Free Free and are RoHS Compliant

#### Specifications

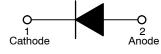
#### ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25°C unless otherwise noted) Symbol Unit Rating Value v **Recurrent Peak Reverse Voltage** V<sub>RRM</sub> 30 v V<sub>RMS</sub> **RMS Reverse Voltage** 21 DC Blocking Voltage 30 V $V_{\mathsf{R}}$ Average Forward Current 3 А IF(AV) Peak Forward Surge Current: 8.3 ms 80 А IFSM Single Half Sine-Wave Superimposed on Rated Load (JEDEC Method) $T_{\rm J}$ °C **Operating Junction Temperature Range** -55 to +150 -55 to +150 °C T<sub>STG</sub> Storage Temperature Range

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



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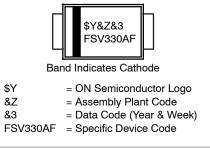


**Schottky Barrier Rectifier** 



CASE 403AD

### MARKING DIAGRAM



### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 2 of this data sheet.

## FSV330AF

#### **THERMAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$ unless otherwise noted)

Symbol	Characteristic	Value	Unit
$\Psi_{JL}$	Typical Thermal Characteristics, Junction-to-Lead (Note 1)	20	°C/W
$R_{\theta JA}$	Typical Thermal Resistance, Junction-to-Ambient (Note 2)	150	°C/W

1. Mounted on FR4 PCB, single-sided cooper, with 48  $\rm cm^2$  pad area.

2. Mounted on FR4 PCB, single-sided cooper, mini pad

### ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
V <sub>F</sub>	Forward Voltage	I <sub>F</sub> = 3 A	-	-	0.5	V
I <sub>R</sub>	Reverse Current	$V_R = V_{DC}, T_A = 85^{\circ}C$	-	-	100	μA
Trr	Reverse Recovery Time	$I_{F} = 0.5 \text{ A}, I_{R} = 1 \text{ A}, I_{rr} = 0.25 \text{ A}$	-	12.50	-	ns
CJ	Junction Capacitance	V <sub>R</sub> = 0 V, f = 1 MHz	-	485	-	pF

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

#### **ORDERING INFORMATION**

Part Number	Top Mark	Package	Shipping <sup>†</sup>
FSV330AF	FSV330AF	DO-214AD (SMAF) (Pb-Free/Halogen Free)	10000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

## FSV330AF

### **TYPICAL PERFORMANCE CHARACTERISTICS**

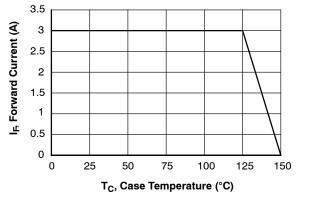


Figure 1. Forward Current Derating Curve

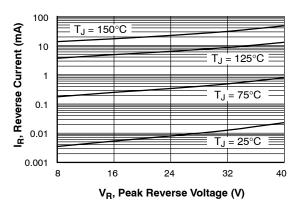


Figure 2. Typical Reverse Characteristics

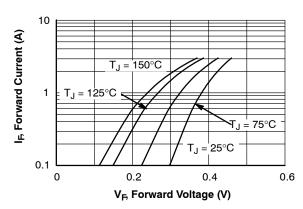


Figure 3. Typical Forward Characteristics

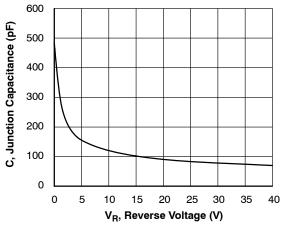
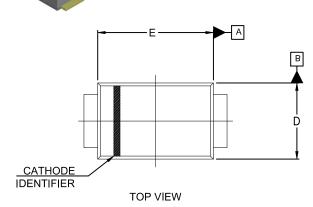


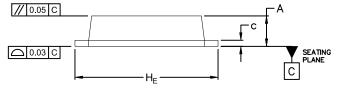
Figure 4. Typical Junction Capacitance



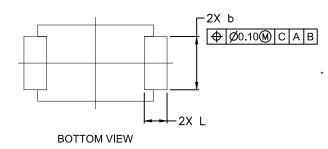
SMA-FL CASE 403AD **ISSUE A** 

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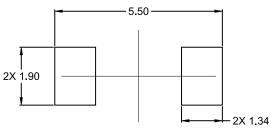
SIDE VIEW



1. 2. 3.

I ES: DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009. CONTROLLING DIMENSION: MILLIMETERS DIMENSIONS D & E ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR EXTRUSIONS.

	MILLIMETERS			
DIM	MIN.	NOM.	MAX.	
А	0.90	1.00	1.10	
b	1.25	1.60	1.90	
С	0.10	-	0.25	
D	2.30	2.50	2.70	
E	3.60	3.95	4.30	
H <sub>E</sub>	4.40	4.80	5.20	
L	0.50	0.75	0.95	



# RECOMMENDED

MOUNTING FOOTPRINT\* For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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